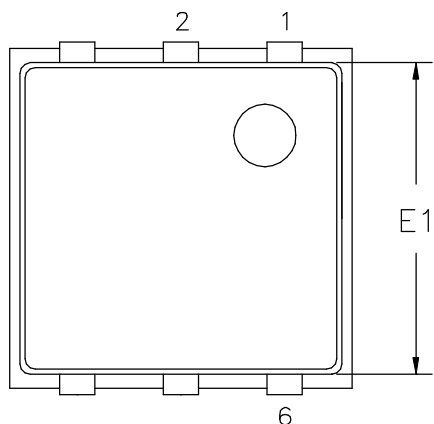
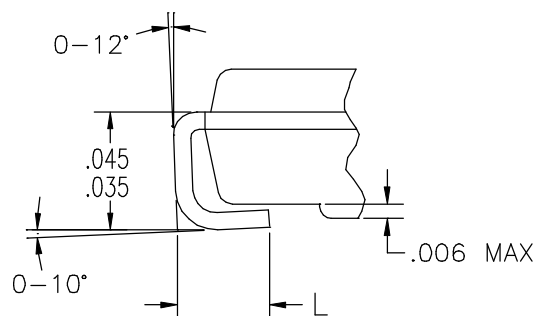
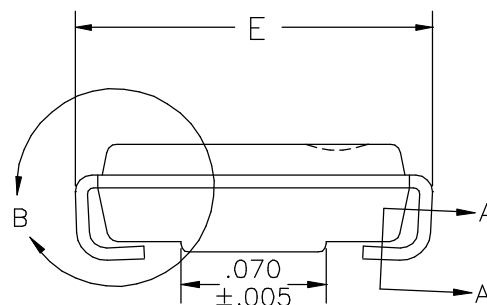


SECTION A-A



DETAIL "B"

SYMBOL	DIMENSIONS INCHES			NOTE
	MIN.	NOM.	MAX.	
A	.051	.055	.059	
B	.016	.017	.019	3
C	.005	.006	.008	
D	.153	.155	.157	2
E	.163	.169	.175	
E1	.144	.150	.152	2
L	.025	.032	.039	

NOTES:

1. CONTROLLING DIMENSIONS: INCHES
2. DIMENSIONS D AND E1 ARE MEASURED AT THE PARTING LINE AND DO NOT INCLUDE FLASH AND PROTRUSIONS; FLASH AND PROTRUSIONS NOT TO EXCEED .008 PER SIDE ON DIM. D AND .011 PER SIDE ON DIM. E1.
3. EXCLUSIVE OF DAMBAR PROTRUSION AND INTRUSION; DAMBAR PROTRUSION AND INTRUSION NOT TO BE POSITIONED ON FOOT OR LOWER RADIUS OF LEAD.

SIGNATURE		DATE		 Dallas Semiconductor TITLE MARKETING OUTLINE, 6 LD. TSOC (THIN SMALL OUTLINE C-LEAD)			
DOC. CONTROL:							
ENGR. MGR:							
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:		SIZE A	FSCM NO	PART NO.		REV C	
DO NOT SCALE DWG.			SCALE N/A		SHEET 1 OF 1		